

**PATENT NUMBER** 

U.S. **UTILITY** Patent Application

SUBCLASS

692

ART UNIT

1765

EXAMINER

09/672776 Fumiyoshî Ono

CONT/PRIOR

CLASS

438

APPLICATION NO.

Composition for polishing metal on semiconductor wafer and method of using same

CROSS REFERENCE(S)

TERMINAL DISCLAIMER	DRAWINGS			CLAIMS ALLOWED
	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims & Print Claim for O.G.
☐ The term of this patent	0 1/10/2 02/20		23/2	NOTICE OF ALLOWANCE MAILED
subsequent to(date) has been disclaimed.	(Assistant	Examiner)	(Date)	
The term of this patent shall not extend beyond the expiration date				
of U.S Patent. No.	1			ISSUE FEE
				Amount Due Date Paid
	(Primary t	Examiner)	(Date)	
The terminalmonths of this patent have been disclaimed.				ISSUE BATCH NUMBER
<u> </u>	(Legal Instrume	ents Examiner)	(Date)	
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